Product Description: ZX122S1EP is PCISIG M.2 power measurement module providing access to PCISIG M.2 power supply rails for purpose of characterizing, test & measurement of PCISIG M.2 supply voltages

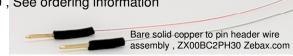
Measure and analyze power supply ripple, transients, Device Under Test, DUT, power consumption and more.

- a) Each power supply rail is designed with current sensing power resistor, please see block diagram.
- b) Utilizing scope probe test equipment, measure power supply noise, ripples, transients, and DUT power consumption.
- c) Utilizing eLoad (Electronic Load), qualify host's power supply & maximum output power.
- d) Identify power supply trace impedance, Rdc , for improved Host / DUT PCB design.

ZX122S1EP features:

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- 1- Pass through PCISIG signals enabling real-time power supply test and measurement.
- 2- Onboard current sense resistors for all supply rails Please see table 1 for details.
- 3- All other traces are pass through designed for 50 Ohms impedance controlled.
- 4- Four layers PCB design, inner layers are GND planes + Exposed copper on top and bottom fill
- 5- Accessible GND exposed copper, enabling for ease of probe access for test and measurement.
- 6- Mates with any key matching M.2 Host and Device / DUT
- 7- The module is shipped with 12pc of probing wires, ZX00BC2PH30, See ordering information



Electrical: Insertion loss > -2dB @6GHz

Trace impedance: 50 Ω

Operating Temperature: -65 °C to +170 °C M.2 Edge Connector type (J1): Key E

Mates with: M.2 Kev E Plating: Gold 100U M.2 Receptacle (J2): Key Type: Key E Height: 0.16" (4.2mm)

Spacer: 2.54mm - See Figure 3

Plating: Gold 100U

Current per pin: 0.5A (maximum)

Current Sense:

 $R1,R2:10m\Omega$ 2512 SMD 7W - Thickness: 0.02" (0.5mm) Max - See Figure 3

Ratings: AEC-Q200

Temperature Coefficient: ±75ppm / °C

Operating Temperature:-65°C to +85°C at 100% listed power rating, see Table 1 -65 °C to +170 °C see section Power Rating on page 3

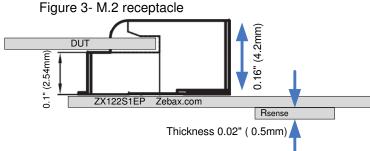
Package: 0402 SMD

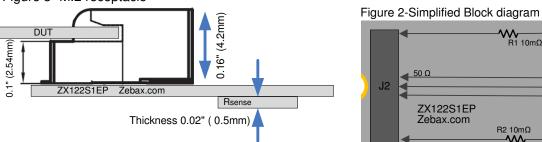
Shunt:

Current Sense resistors: Table 1 lists onboard ZX122S1EP current sense resistors and associated PCISIG M.2 connector assignment

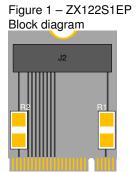
Table 1

able i					
Current Sense Resistor	PCISIG M.2 Connector pin	PCISIG M.2 Supply Rail	Description	Package	
Current Sense Resistor	number	PCISIG WI.2 Supply Hall	Description	(inch)	(mm)
R1	2, 4	3.3 V	10m Ohms 1% 7W	2512	6432
R2	72, 74	3.3 V	10m Ohms 1% 7W	2512	6432

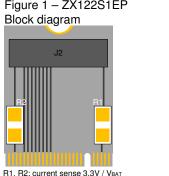




50 Ω : All traces are designed 50 $\overline{\Omega}$ impedance control J2: PCISIG M.2 receptacle connector



ZEBAX.com ZX122S1EP



1.029" (26mm)

.18" (30mm)

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ZX122S1EP

Zebax.com

ZX122S1EP package includes:

Part number ZX122S1EP ZX00BC2PH30	PCB Edge Key E	J2 Key E	1	Description M.2 PCISIG Socket 1 power measurement module 30AWG Bare Copper wire to pin header wire assembly		
ZX00BC2PH30 site page for ordering ZX00BC2PH30 wire assembly						

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ASSEMBLY DRAWING

ITEM: ZX122S1EP

PCISIG M.2 NGFF Socket 1 Key E passive DESCRIPTION: power measurement module

CHECKED: DRAWN: M. MARINA

REVISSION: 1.0 MATTHEW CT SHEET: 1 OF 3

Compliance: ISO2001 certified

RoHs - Lead Free EU RoHS2 UL E111594 document ELV- Vehicle Directive (Directive 2000/EC) European Union Directive (203/11/EC) Halogen Free per IEC-61249-2.21: 2003

RoHs Directive 2011/65/EU WEEE Directive (2012/12/EU)

Certificate of Compliance for Radioactive substances

Certificate of Compliance for Asbestos

Certificate of Compliance for Ozone Depleting Substances, ODS

Certificate REACH SVHC

Certificate of Compliance RoHS EN CoC

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Current Sense resistors: The current sense resistors may be removed if external electronic

load, eLoad, is used. eLoad test equipment may be applied to ZX122S1EP for power supply characterization, test and measurements, Eload suppliers; BK Precision, Chroma, Instek, Kikusui and more

Please note: Table 2 represents only the PCISIG M.2 Socket 1 Key E power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 1 Kev E" applications.

Table 2 – PCISIG M.2 Socket 1 Kev E

		Socke	et 1 Key	E		
	PC	ISIG M.2	connec	tor pin		
Signal	Pin	ZX122S1EP		Pi	_	Signal
		Label ¹	Lab	el ¹	11	
3.3 V	74	R2		75	5	GND
3.3 V	72	n2		69)	GND
	30			63	3	GND
ADD-IN CARD KEY E	28		EF	2 57	,	GND
ADD-IN OAND KET E	26	i I	-	51		GND
	24			45	5	GND
GND	18	EP ²		39)	GND
3.3 V	4	R1		33	3	GND
3.3 V	2	n i		31		
				29	9	ADD-IN CARD KEY E
				27	,	ADD-IN CARD RET E
				25	5	
			EF	2 7		GND
				1		GND

Signal assignments: Table 2 exhibits the routed M.2 PCISIG signals on the ZX122S1EP module.

Please note: Table 2 represents only the PCISIG M.2 Socket 1 Key E power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 1 Key E" applications.

Ground / Exposed Copper:

All of the PCISIG M.2 GND, reference ground, signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S1EP is the module's GND for purpose of rework and probing purpose.

PCISIG M.2 signals:

Е

ZX1221EP passes through all PCISIG M.2 signals (excluding the power supply rails . All traces are 50 Ohms impedance controlled. ZX122S1EP passes through the reserved "NC" No Connect signals as well.

Bringup, testing, emulation, development, modular design evaluations

M.2 PCISIG Socket power supply test characterization SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module Socket 1 Add-in Card Key E-E, Socket 1 DisplayPort Key E, Socket 1 SDIO Key E Socket 2 WWAN Key C . Socket 2 PCle-based SSD Key B-M . Socket 2 SATA-based SSD Key B-M Socket 2 PCIe / USB 3.1 Gen1-Based WWAN Key B, Socket2 PCIe-Based WWAN Key B Socket 2 USB3.1 Gen1-based WWAN Key B, Socket 2 SSIC WWAN Key B Socket 3 PCIe-based Key M, Socket 3 SATA-based Key M

Mates with: Any standard M.2 NGFF PCISIG connector on host and device Key E

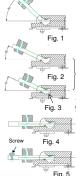
TE 2199125 2199119 2199230 2199133 JAE SM3ZS067

Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol

Module Insertion, Removal process:

In order to avoid any mechanical stress or damage to ZX122S1EP, please follow the below listed guidelines for insertion and removal process:

- 1- Move the Module against the housing chamber, see figure 1
- 2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3



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Figure 4 – Typical application - Rx, Ry: Current sense resistors

ASSEMBLY DRAWING

ZX122S1EP

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ITEM: ZX122S1EP

PCISIG M.2 NGFF Socket 1 Key E passive **DESCRIPTION:** power measurement module

CHECKED: M. MARINA

MATTHEW CT

REVISSION: 1.0

3- Rotate the module to horizontal position, see figure 4 4- Fix the module by screw, see figure 5

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SHEET: 2 OF 3

Product Name: ZX122S1EP PCISIG M.2 NGFF Socket 1 Key A passive power measurement module – Page 3 of 3

Typical Application: ZX122S1EP is designed for purpose of PCISIG M.2 power supply characterization, test and debug at full

connector's bandwidth. It provides onboard current sense resistors where scope probe could be utilized for measuring characterization data for qualifying the host or device functional behavior. Additionally, the current sense resistors may be replaced by eLoad for transient and dynamic load throttling. Below are few suggestions in respect to proper power supply measurements using ZX122S1EP module:

Scope Probe wire Installation:

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Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible - Based on availability of type of scope + probing options, install probe wire as listed below

- 1- It is recommended to keep the +probe wire length at 0.5" (1.2cm) long.
- 2- In order to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND reference. ZX122S1EP provides several exposed copper test points for probing purpose.
- 3- Ensure scope probe's bandwidth is set at 20MHz Certain tests require full scope + scope probe bandwidth; however, industry standard is 20MHz bandwidth for power supply test and measurements.
- 3- Both Keysight as well as Tektronix offer variety of single ended as well as differential probes along with their accessories, below are few probes from each vendor:
 - a) Keysight differential probe or similar N2795A, N2796A, 1168V, 1134B along with E2677B differential Solder-in probe, N5426A ZIF Tip, N2884A Fine Wire ZIF Tip and more - See the figure "probe head accessories".
 - b) Tektronix offers several single-ended as well as differential probes such as: P6243, P6245, P6248, P6246, P6247 or any TP1500, TAP2500, TAP3500, TAP4000, P7240 of TDP7000 series or equivalent
- 4- Please follow your vendor's guideline in installation of probe wires & accessories.

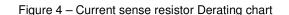
Power Rating: Onboard current sense resistors on ZX122S1EP module are designed for maximum power consumption per PCISIG M.2 specification operating within -65 ℃ to 85 ℃ temperature range. The current sense resistor's power rating will degrade at above 85 ℃ test environment. It is highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin (0.5A per pin) at above 85 °C test environment.

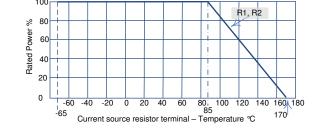
> The onboard current sense resistors operate at 100% listed power ratings (see Table 1) within temperature range: R1, R2: -65° C \leq operating temperatures \leq 85 $^{\circ}$ C with tolerance = \pm 1%

The onboard current sense resistors **power ratings** derail at **above** 85 ℃. Figure 4 exhibits the current sense resistors derating curve. Current sense resistors rated power; $P = VI = I^{**}2 \times R$ where I is the maximum current for the listed resistor value R

Below are few suggestions, if your test & measurement environment falls ≥ +85 °C temperature range:

- 1- Apply cooling fan where the current sense resistor's terminal blocks are measured at 85 °C Please note The ZX122S1EP module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method.
- 2- Replace the onboard current sense resistors with lower values (similar footprint), resulting at higher power ratings at ≥ 85 °C test environment.
- 3- Replace onboard current sense resistors with eLoad (electronic Load Board / System) eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation.





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Keysight Probe Head accessories nfiniiMax RC Probe Heads InfiniiMax I Probe Heads N5381B Diff. Solder-In E2677B Diff. Solder-In MX0100A Diff. Micro MX0103A Bullet Adapter E2678B Diff. Socketed N5380B SMA MX0106A Diff. Solder-In 8 0 0009 E2675B Diff, Browser N5425B ZIF N2839A Diff. Browser N2884A Fine Wire ZIF Tip N5451A Long-Wired ZIF Tip (7 mm) MX0105A Diff. SMA N5451A Long-Wired



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ASSEMBLY DRAWING

ITEM: ZX122S1EP

DESCRIPTION:

PCISIG M.2 NGFF Socket 1 Key E passive power measurement module

CHECKED: M. MARINA

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REVISSION: 1.0

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SHEET: 3 OF 3